STBC08

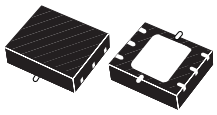
800mA Standalone linear Li-Ion Battery charger with thermal regulation

Feature summary

- Programmable charge current up to 800mA
- No external MOSFET, sense resistors or blocking diode required
- Complete linear charger for single cell lithium-ion batteries
- Constant current / constant voltage operation with thermal regulation to maximize charge rate without risk of overheating
- Two charge status output pins
- Charges single cell li-ion batteries directly from USB port
- Preset 4.2V charge voltage with 1% accuracy
- Charge current monitor for gas gauging
- Automatic recharge
- Under-voltage lockout
- C/10 Charge termination
- 25µA supply current in shutdown mode
- Low battery voltage detect for precharge setting
- Soft-start feature limits inrush current
- DFN6 (3x3mm) package (for better power dissipation)

Applications

- Cellular telephones
- PDAs
- Bluetooth applications
- Battery-powered devices



DFN6 (3x3mm)

Description

The STBC08 is a constant current/constant voltage charger for single cell Li-Ion batteries. No external sense resistor or blocking diode is required.

The STBC08 is designed to work within USB power specifications. An internal block regulates the current when the junction temperature increases, in order to protect the device when it operates in high power or high ambient temperature conditions.

The charge voltage is fixed at 4.2V, and current limitation can be programmed using a single resistor connected between PROG pin and GND. The charge cycle is automatically terminated when the current flowing to the battery is 1/10 of the programmed value. If the external adaptor is removed, the STBC08 turns off and a 2µA current can flow from the battery to the device. The device can be put into Shutdown Mode, reducing the supply current to 25µA. The device also has a charge current monitor, under voltage lockout, automatic recharge. The charge termination and input voltage presence are indicated by two separate status pins.

Order code

Part number	Package	Packaging
STBC08PMR	QFN6 (3mm x 3mm)	4500 parts per reel

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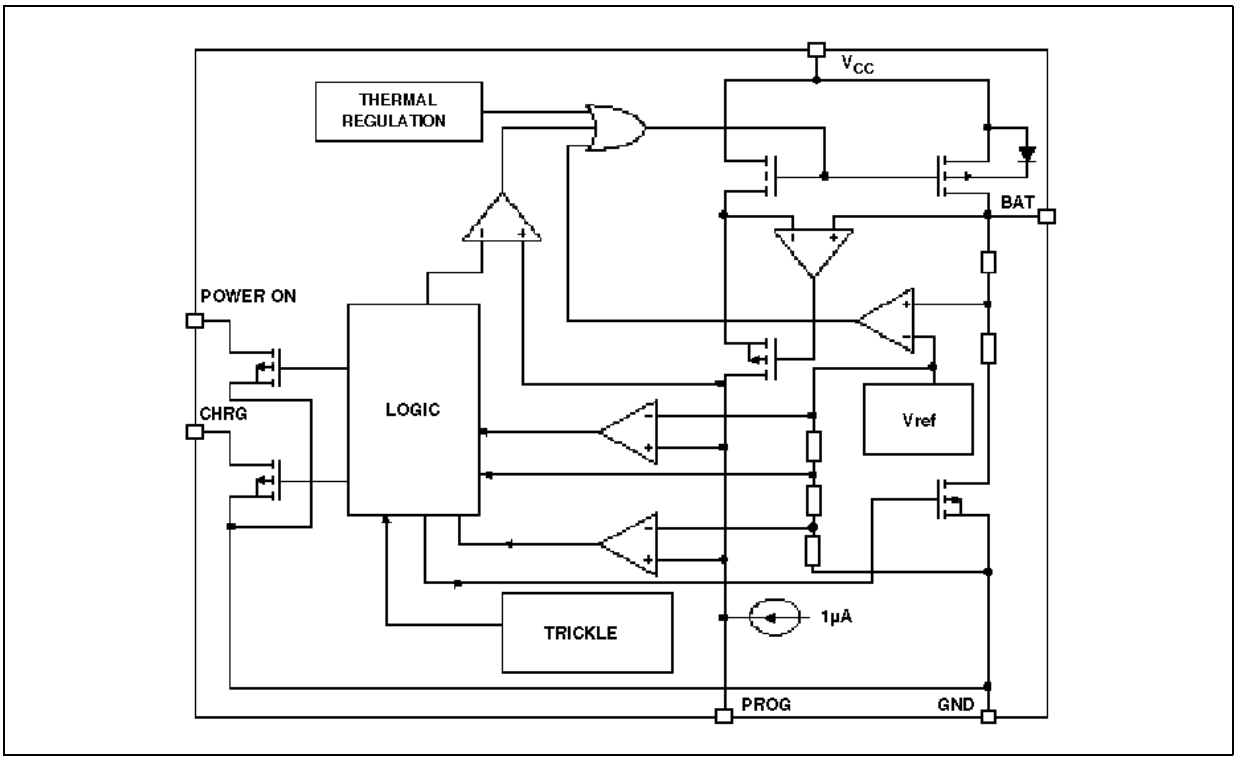
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1 Block diagram

Figure 1. Block diagram



2 Pin configuration

Figure 2. Pin connections (top view)

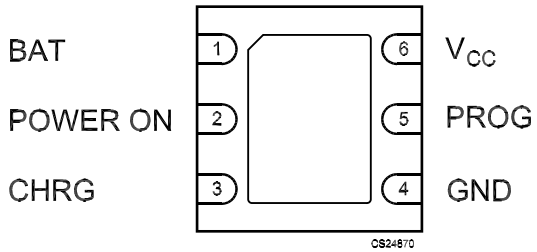
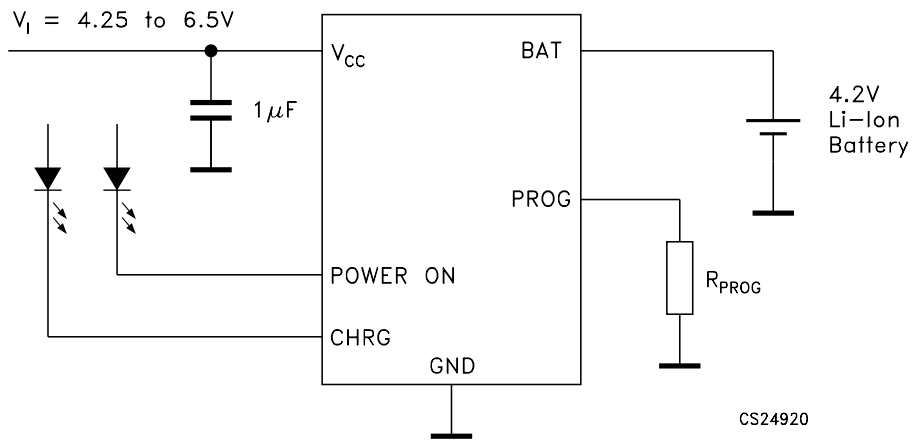


Table 1. Pin description

Pin N°	Symbol	Note
1	BAT	This pin provides an accurate 4.2V output voltage and the charge current to the battery. Only 2µA reverse current can flow in to the device when in Shutdown mode
2	POWER ON	Open Drain. When the STBC08 detects an undervoltage lockout condition or when the external adaptor provide an input voltage higher than 7.2V or less than battery voltage, POWER ON goes in high impedance state
3	CHRG	Open Drain. This pin goes in low impedance when the STBC08 is in precharge or charge mode
4	GND	Ground pin
5	PROG	Charge current program. Charge Current monitor and shutdown pin. The current limitation is programmed using a 1% tolerance R_{PROG} between PROG pin and GND
6	V_{CC}	Input supply voltage. The input range is from 4.25 to 6.5V. If V_{CC}<V_{BAT}+30mV the device enters Shutdown mode and the sinked I_{BAT} is less than 2µA

Figure 3. Application circuit



3 Maximum ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{cc}	Input supply voltage	From -0.3 to 10	V
V_{BAT}	BAT pin voltage	From -0.3 to V_{CC}+0.3	V
V_{PROG}	PROG pin voltage	From -0.3 to V_{CC}+0.3	V
V_{CHRG}	CHRG pin voltage	From -0.3 to 7	V
$V_{POWER-OM}$	POWER ON pin voltage	From -0.3 to 7	V
I_{BAT}	BAT pin current	800	mA
I_{PROG}	PROG pin current	800	µA
	BAT short circuit duration	Continuous	
P_D	Power dissipation	Internally Limited	mW
T_J	Max junction temperature	125	°C
T_{STG}	Storage temperature range	-65 to 125	°C
T_{OP}	Operating junction temperature range	-40 to 85	°C

Table 3. Thermal Data

Symbol	Parameter	Value	Unit
R_{thJA}	Thermal Resistance Junction-Ambient	105.7	°C/W

4 Electrical characteristics

Table 4. Electrical characteristics
(V_{CC} = 5V, C_I = 1µF, T_J = -40 to 85° unless otherwise specified) (*Note 2*).

Symbol	Parameter	Test		Min.	Typ.	Max.	Unit
V_{CC}	Supply voltage			4.25		6.5	V
I_{CC}	Supply current (*Note 1*)	Charge mode, R_{PROG} =10KΩ			150	500	µA
		Standby mode (charge terminated)			150	300	
		Shutdown mode	R_{PROG} not connected		21	40	
			V_{CC} < V_{BAT}		17	50	
			V_{CC} < V_{UV}		17	40	
V_{BAT}	Termination output voltage	V_{CC} = 4.3V to 6.5V		4.158	4.2	4.242	V
I_{BAT}	BAT pin current	Current mode R_{PROG}=10KΩ		90	100	110	mA
		Current mode R_{PROG}=2KΩ		465	500	535	mA
		Standby mode V_{BAT}=4.2V		0	-2.5	-6	µA
		Shutdown mode (R_{PROG} not connected), T_J=25°C			±1	±2	µA
		Sleep mode, V_{CC}=0V, T_J=25°C			±1	±2	µA
I_{PRE}	Pre-charge current	V_{BAT}<2.8V R_{PROG} =2KΩ T_J=25°C		20	45	70	mA
V_{PRE}	Pre-charge threshold	R_{PROG} =10KΩ V_{BAT} falling		2.8	2.9	3.0	V
		Hysteresis R_{PROG} =10KΩ		70	100	130	mV
V_{UV}	V_{CC} Undervoltage lockout	V_{CC} Low to High R_{PROG} =10KΩ		3.65	3.80	3.95	V
		Hysteresis R_{PROG} =10KΩ		50	180	300	mV
V_{MSD}	Manual shutdown threshold	PROG Pin Rising		1.15	1.21	1.30	V
		PROG Pin Falling		0.85	0.95	1.05	
V_{ASD}	V_{CC}-V_{BAT} Lockout threshold	V_{CC} Low to High T_J=25°C R_{PROG} =10KΩ		50	85	120	mV
		V_{CC} High to Low T_J=25°C R_{PROG} =10KΩ		5	30	50	
I_{TERM}	C/10 Termination current threshold (I_{BAT}/I_{BATC10}) (*Note 3*)	R_{PROG} =10KΩ			0.1		mA/mA
		R_{PROG} =2KΩ			0.1		
V_{PROG}	PROG pin voltage	Current Mode R_{PROG} =10KΩ		0.93	1.0	1.07	V
V_{CHRG}	CHRG Pin pull-down voltage	I_{CHRG}=5mA			0.35	0.6	V
I_{POWER_ON}	POWER–ON pin leakage current	Pull-up				1	µA
I_{POWER_ON}	POWER–ON pin pull-down voltage	$I_{POWER-ON}$=5mA			0.35	0.6	V

Table 4. Electrical characteristics
(V_{CC} = 5V, C_I = 1µF, T_J = -40 to 85° unless otherwise specified) (*Note 2*).

Symbol	Parameter	Test	Min.	Typ.	Max.	Unit
ΔV_{RECHRG}	Recharger battery threshold voltage	Battery Voltage T_J=25°C R_{PROG} =10KΩ		200		mV
T_{LIM}	Junction temperature in constant temperature mode			120		°C
R_{ON}	Power Fet “ON” resistance (Between V_{CC} and BAT)			600		mΩ
t_{SS}	Soft-start time	I_{BAT}=0 to I_{BAT}=1000V/R_{PROG}		100		µs
$T_{RECHARGE}$	Recharge comparator filter time *Note 4*	V_{BAT} High to Low	0.75	2	4.5	ms
t_{TERM}	Termination comparator filter time *Note 4*	I_{BAT} Falling Below I_{CHG}/10	400	1000	2500	µs
I_{PROG}	PROG pin pull-up current			1		µA

Note: 1 Supply current includes PROG pin current but not any current delivered to the battery through the V_{BAT} pin.

2 The STBC08 was tested using a battery simulator and an output capacitor value of 4.7µF

3 I_{TERM} is expressed as a fraction of measured full charge current with indicated PROG resistor

4 Guaranteed by design

5 Typical performance characteristics

Figure 4. I_{BAT} vs Supply voltage

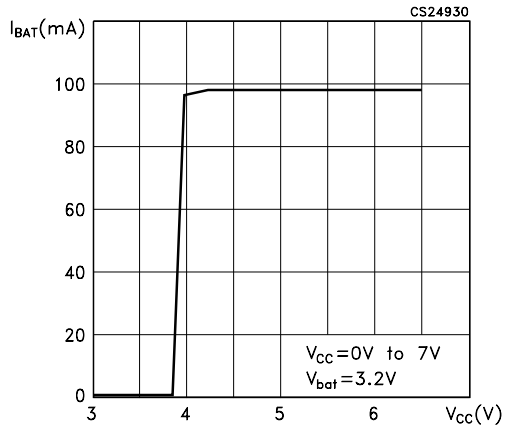


Figure 5. V_{BAT} vs V_{CC}

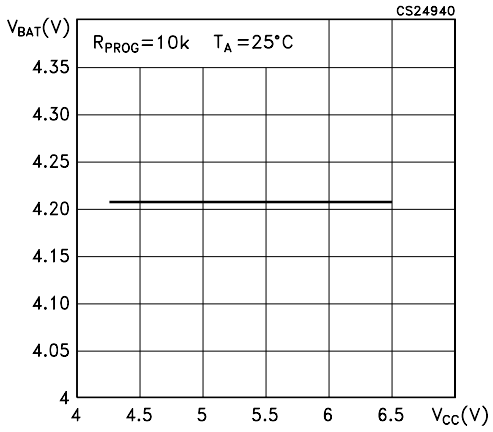


Figure 6. I_{BAT} vs temperature

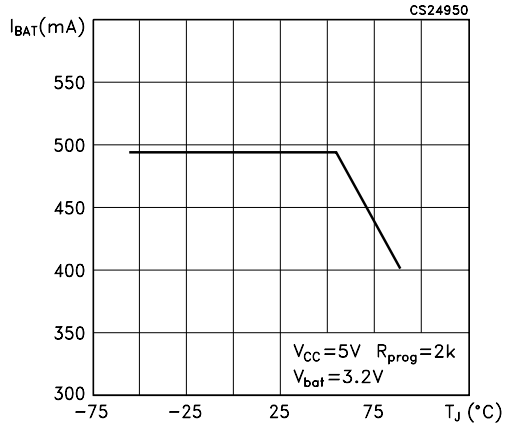


Figure 7. V_{PROG} vs temperature

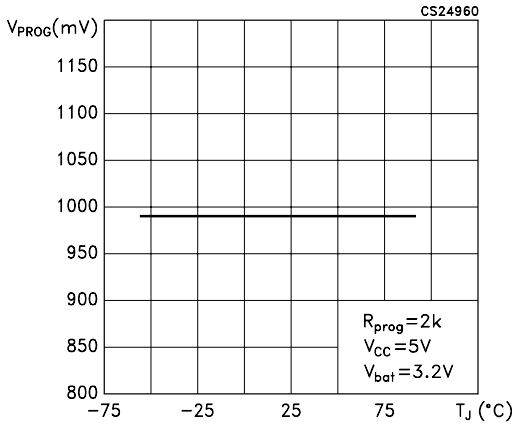


Figure 8. I_{BAT}/I_{PROG} vs temperature

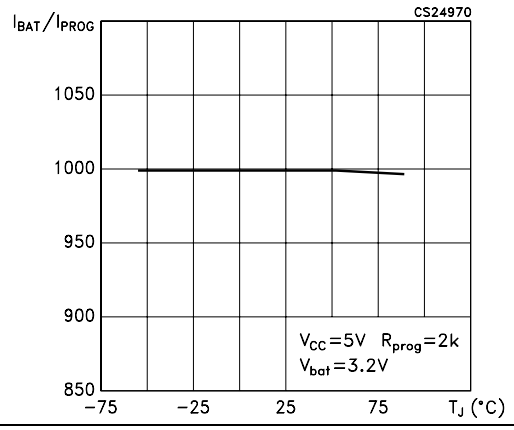


Figure 9. Recharge battery threshold voltage vs. temperature

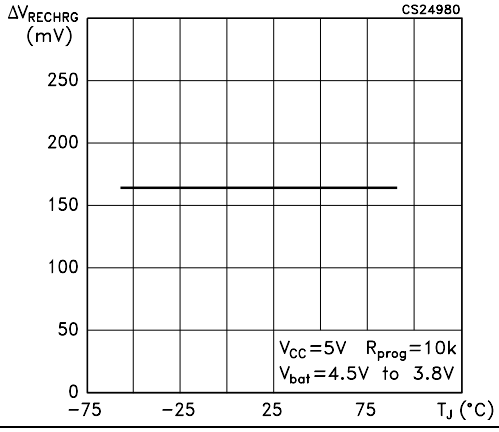


Figure 10. I_{BAT}/I_{PROG} vs V_{CC}

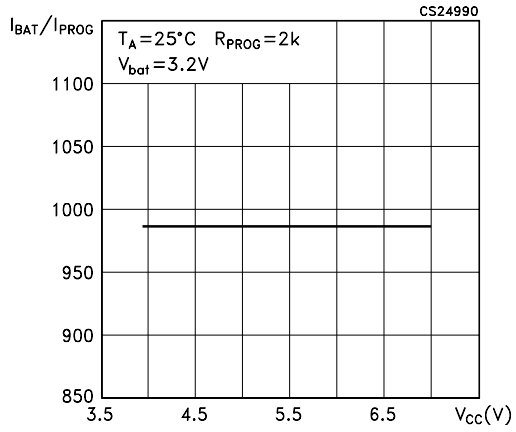


Figure 11. I_{BAT} vs V_{BAT}

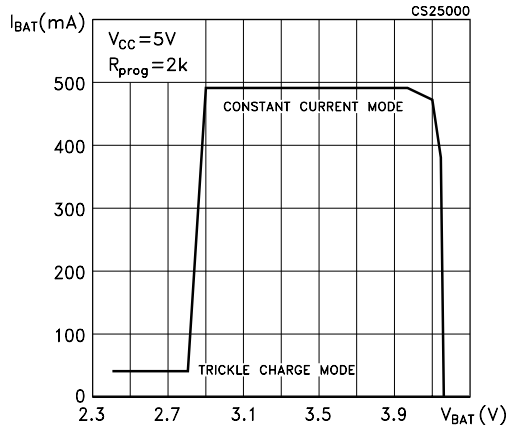


Figure 12. V_{CHRG} vs temperature (CHRG pin output low voltage)

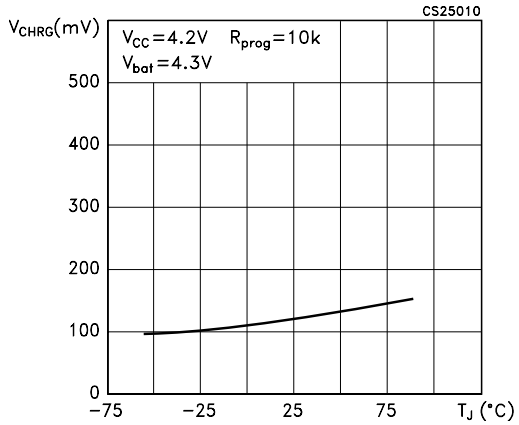


Figure 13. I_{BAT} vs V_{PROG}

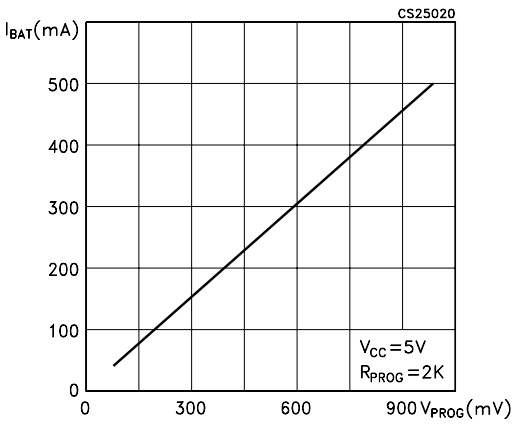
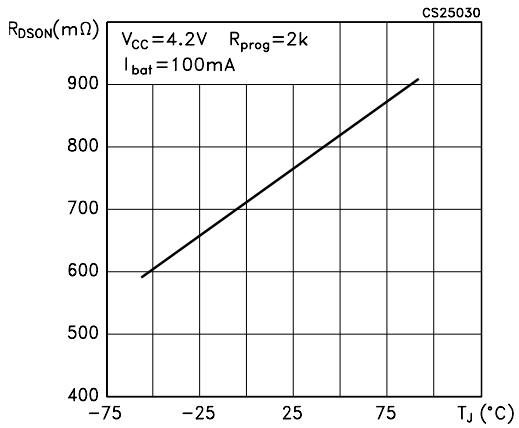


Figure 14. Power FET “ON” resistance



6 Application information

The STBC08 uses an internal P-Channel MOSFET to work in constant current and constant voltage method. It is able to provide up to 800mA with a final regulated output voltage of 4.2V ±1% in full temperature range. No blocking diode and sensing resistor are required. It is also possible to use an USB port as power supply voltage.

6.1 Charge cycle

A charge cycle begins when the voltage at the V_{CC} pin rises above the UVLO threshold level, the R_{PROG} program resistor of 1% is connected between the PROG pin to GND pin and when a battery is connected to the charger output. If the battery voltage is below 2.9V, the charger enters Trickle Charge mode. In this condition, the device supplies 1/10 of the programmed charge current to bring the battery voltage up to safe level otherwise the life of a battery is reduced. If the BAT pin voltage is higher than 2.9V the charger enters in Constant Current Mode. When the BAT pin voltage is close to the final float voltage (4.2V) the device enters in Constant Voltage Mode and the charge current begins to decrease. The charge cycle is terminated when the current drops to 1/10 of the programmed value.

6.2 V_{CC} Pin

Input Supply Voltage. This pin is used to supplie the device in the range from 4.25V to 6.5V voltage. A bypass capacitor of 1µF is recommended for use. When V_{CC} value drops of 30mV of the BAT pin voltage, the device enters in Shutdown Mode, dropping I_{BAT} to less than 2µA.

6.3 Power ON pin

The POWER ON pin is an open drain flag that indicates V_{CC} presence, $V_{UVLO}<V_{CC}<7.2V$ and $V_{CC}>V_{BAT}$. While in high impedance indicates that $V_{CC}< V_{UVLO}$, $V_{CC}>7.2V$ or $V_{CC}<V_{BAT}$. In high impedance status the V_{CC} is insufficient to start the charge cycle.

6.4 CHRG pin

The CHRG pin is an open drain flag, it indicates the status of the charge. When the pin is in low state, the device is charging the battery. If the pin is in high impedance state the charge is terminated.

Table 5. CHRG

		CHRG	
		LOW	HIGH
Power-ON	LOW	00	01
	HIGH	-	11

Table 5 describes Flag Status values for the CHRG pin.

-00 is Precharge Mode (Trickle charge mode) or Charge Mode. V_{CC} is higher than V_{UVLO} and R_{PROG} is connected to the PROG pin.

- 01 is STANBY MODE (charge completed) or SHUTDOWN MODE (R_{PROG} not connected).

- 11 supply is not sufficient.

6.5 PROG pin

Charge Current Program, Charge Current Monitor and Shutdown Pin. The charge current is programmed by connecting a 1% resistor, R_{PROG}, to ground. When the device is charging in constant current, the value of voltage on this pin is 1.0V. In other conditions, the voltage on this pin can be used to measure the charge current using the following formula:

$$I_{BAT} = (V_{PROG}/R_{PROG})*1000$$

The PROG pin is used to shut down the device, disconnecting the program resistor from ground a 1µA current flows to pull the PROG pin high. If the value of this Pin is 1.21V (shutdown threshold voltage), the device enters Shutdown mode and the input supply current drops to 25µA. Driving this pin to voltage beyond 2.4V a current of 35µA flows into the device from PROG pin.

6.6 Programming charge current

The R_{PROG} resistor is used to set the charge current value. The battery charge current is 1000 times the Prog pin current value. The program resistor and the charge current are calculated using the following formula:

$R_{PROG}=1000*V_{PROG}/I_{BAT}$;

The charge current out of the BAT pin can be monitored through the PROG pin voltage using the following equation:

$I_{BAT}=(V_{PROG}/R_{PROG})x1000$

6.7 BAT pin

Charge Current Output pin. It provides charge current to the battery and regulates the final float voltage to 4.2V. An internal precision resistor is used as a feedback loop to compare the V_O with the reference.

6.8 Charge termination

A charge cycle is terminated when the final float voltage is reached consequently the charge current falls to 1/10th of the programmed value. The charge is over when the PROG pin voltage falls below 100mV for longer time than t_{TERM} (~1ms). The charge current is latched off, the device enters in standby mode and the input supply current drops to 200µA.

6.9 Automatic recharge

The device restarts the charge cycle when the battery voltage falls below 4.05V to maintain the battery capacity value higher than 80%. During the recharge time, the CHRG pin goes low state.

6.10 Soft start

When a charge cycle starts, a internal soft start circuit minimizes the inrush current. At starting phase, the charge current ramps from zero to the full scale in a 100µs period time.

6.11 Thermal regulation

An internal thermal feedback loop reduces the output current if the die temperature attempts to rise above a present value of approximately 120°C. This feature protects the device from excessive temperature and allows the user to push the limits of the power handling capability of a given circuit board without risk of damaging the device.

6.12 Power dissipation

It is very important to use a good thermal PC board layout to maximize the available output current. The thermal path for the heat generated by the IC is from the die to the copper lead frame through the package leads and exposed pad to the PC board copper. The PC board copper is the heat sink. The footprint copper pads should be as wide as possible and expand out to larger copper areas to spread and dissipate the heat to the surrounding ambient. Feed through vias to inner or backside copper layers are also useful in improving the overall thermal performance of the device. Other heat sources on the board, not related to the device, must also be considered when designing a PC board layout because they will affect overall temperature rise and the maximum output current.

6.13 Stability considerations

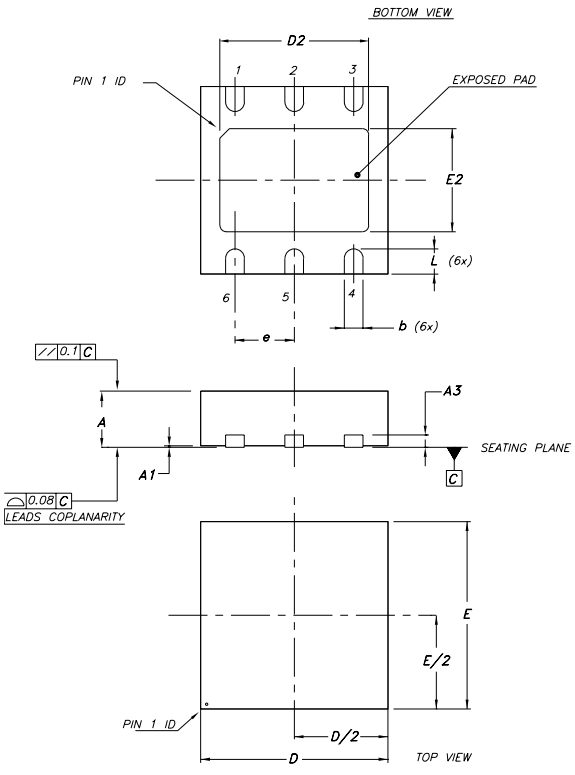
The STBC08 contains two control loops: constant voltage and constant current. The constant-voltage loop is stable without any compensation when a battery is connected with low impedance leads. Excessive lead length, however, may add enough series inductance to require a bypass capacitor of at least 1µF from BAT to GND. Furthermore, a 4.7µF capacitor with a 0.2Ω to 1Ω series resistor from BAT to GND is required to keep ripple voltage low when the battery is disconnected.

7 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

DFN6 (3x3) MECHANICAL DATA

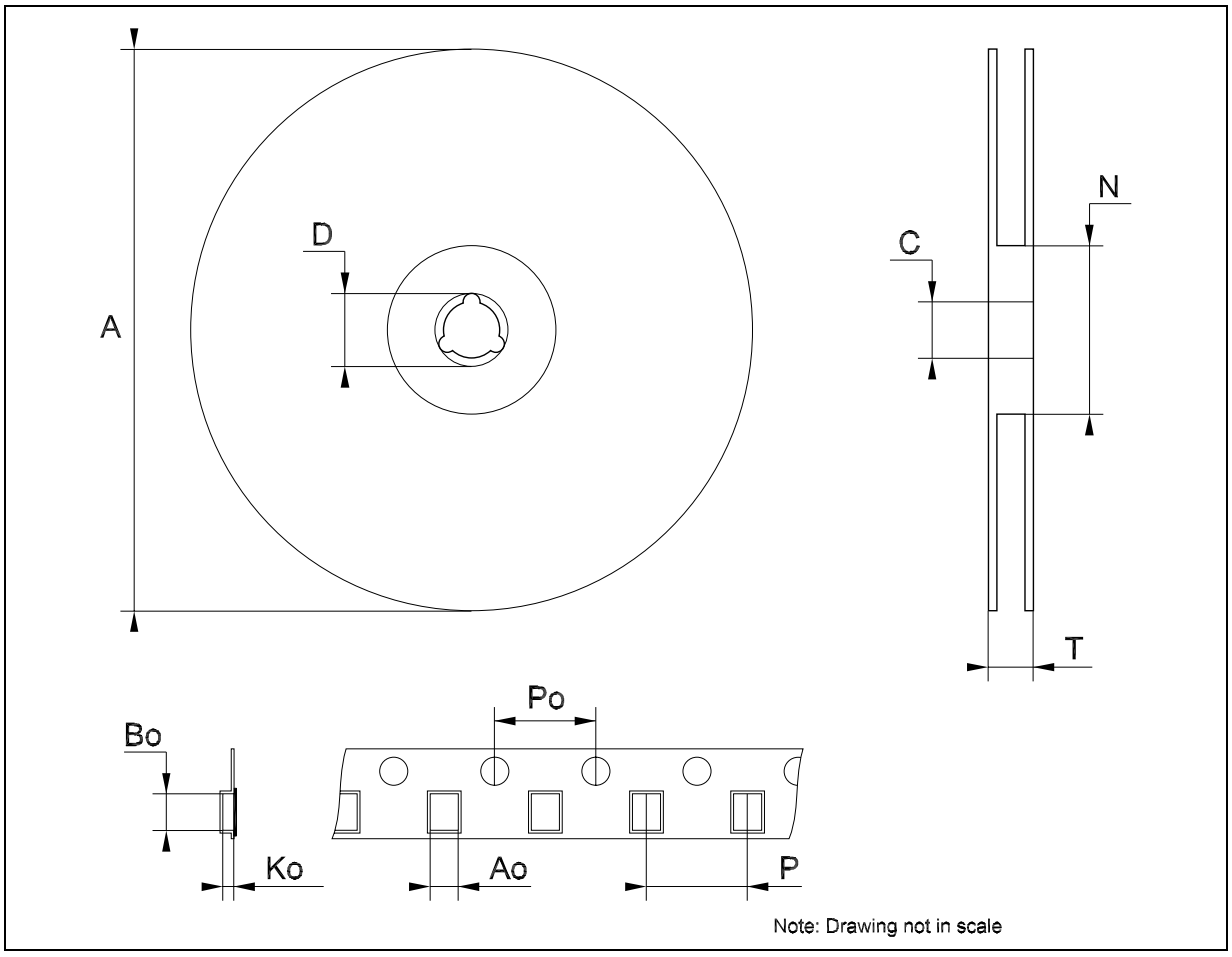
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	0.80	0.90	1.00	0.031	0.035	0.039
A1	0	0.02	0.05	0	0.001	0.002
A3		0.20			0.008	
b	0.23	0.30	0.38	0.009	0.012	0.015
D	2.90	3.00	3.10	0.114	0.118	0.122
D2	2.23	2.38	2.48	0.088	0.094	0.098
E	2.90	3.00	3.10	0.114	0.118	0.122
E2	1.50	1.65	1.75	0.059	0.065	0.069
e		0.95			0.037	
L	0.30	0.40	0.50	0.012	0.016	0.020



7946637A

Tape & Reel QFNxx/DFNxx (3x3) MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			18.4			0.724
Ao		3.3			0.130	
Bo		3.3			0.130	
Ko		1.1			0.043	
Po		4			0.157	
P		8			0.315	



Note: Drawing not in scale

8 Revision history

Table 6. Revision history

Date	Revision	Changes
04-Sep-2006	1	Initial release.

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